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PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

ENTOR:

Todd H. Buley

EXAMINER:

Johnathan J. Johnson

SERIAL NO:

10/605,257

GROUP ART

1725

UNIT:

FILING DATE: September 18, 2003

DATE:

October 11, 2005

TITLE:

INCLINED SOLDER WAVE METHODOLOGY FOR WAVE

SOLDERING DOUBLE SIDED PIN-IN-HOLE ELECTRONIC

COMPONENTS

TRANSMITTAL OF FORMAL DRAWINGS

MAIL STOP ISSUE FEE

Commissioner of Patents P.O. Box 1450 Alexandria, VA 22313-1450

ATTN: OFFICIAL DRAFTSPERSON

Dear Sir:

Enclosed are 3 sheets of formal drawings for the above-identified application. Kindly replace the informal drawings, as filed, with the enclosed drawings. No new matter has been added.

Please charge our Deposit Account No. 09-0458 for any fee relative to the acceptance of the attached formal drawings. A duplicate copy of this letter is enclosed for that purpose.

Respectfully submitted,

Peter W. Peterson Reg. No. 31,867

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